Long all-active monolithic mode-locked lasers with surface-etched bragg gratings

Larsson, David; Yvind, Kresten; Hvam, Jørn Märcher

Published in:
IEEE Photonics Technology Letters

Link to article, DOI:
10.1109/LPT.2007.905680

Publication date:
2007

Document Version
Publisher's PDF, also known as Version of record

Link back to DTU Orbit

Citation (APA):

General rights
Copyright and moral rights for the publications made accessible in the public portal are retained by the authors and/or other copyright owners and it is a condition of accessing publications that users recognise and abide by the legal requirements associated with these rights.

- Users may download and print one copy of any publication from the public portal for the purpose of private study or research.
- You may not further distribute the material or use it for any profit-making activity or commercial gain
- You may freely distribute the URL identifying the publication in the public portal

If you believe that this document breaches copyright please contact us providing details, and we will remove access to the work immediately and investigate your claim.
Long All-Active Monolithic Mode-Locked Lasers With Surface-Etched Bragg Gratings

David Larsson, Kresten Yvind, and Jørn M. Hvam

Abstract—We have fabricated 4.4-mm-long monolithic InAlGaAsP-InP mode-locked lasers with integrated deeply surface etched distributed Bragg reflector (DBR) mirrors. The lasers produce 3.7-ps transform-limited Gaussian pulses with 10-mW average output power and 250-fs absolute timing jitter. The performance of the DBR lasers is compared to the performance of Fabry–Pérot mode-locked lasers from the same wafer and to the performance of earlier reported long monolithic DBR mode-locked lasers and is found to be better.

Index Terms—Distributed Bragg reflector (DBR), mode-locked laser diode, optical communications.

I. INTRODUCTION

MONOLITHIC mode-locked lasers (MMLLS) are attractive as compact pulse sources in high-speed optical communication systems [1], in microwave photonics [1], and in high-speed optical sampling [2]. Distributed Bragg reflectors (DBRs) or other types of filters are needed in these lasers to control the spectral bandwidth, the center wavelength, and to obtain repetition rate tuning of the pulses [4]. DBRs also offer the possibility of further integration with other optical elements, e.g., modulators, amplifiers, and detectors.

There are only a few reports on long (~10 GHz) MMLLS with integrated wavelength-selective filters at a wavelength of 1.55 μm. The ones reported suffered from low output power (<1 mW) [3], [4], and long pulses (6.1 ps) [3], (>9 ps) [4], [5]. Furthermore, detailed noise characterization has not been reported before. We present a laser that combines an active material design for short pulses with high power and low noise [6], with a deeply surface-etched DBR. To our knowledge, this is the first time an MMLL is integrated with a surface-etched DBR. The potential advantages of surface-etched DBRs compared to conventional regrown DBRs are large index contrasts, Al-containing layers can be used for and below the grating without the risk of oxidation, the diffused growth on the corrugated surface is omitted, and finally the cost is reduced since no in-house epitaxial growth is necessary. Surface-etched DBRs have been reported for single-mode lasers (mostly GaAs-based) by the University of Illinois with good results, e.g., K > 100 cm⁻¹ in [7].

II. DESIGN AND FABRICATION

The epitaxial structure is similar to [6], with one 7-nm In₀.₃₁Ga₀.₆₉As₀.₉₀P₀.₁₀ quantum well as the gain material and Al₀.₃₄Ga₀.₆₆In₀.₇₃As barriers, and is grown in a single epitaxial step. The integration of the DBR is performed by surface-etching the grating and the ridge simultaneously. A combined grating and ridge mask in 200-nm SiO₂ is defined by first e-beam lithography and then UV lithography. The 2.4-μm-wide ridge and the 364-nm grating trenched (third-order 50% duty cycle) are then etched to 2125-nm depth with a CH₄-H₂ (1:4) reactive ion etching (RIE) (pressure: 25 mTorr; Vₑ₂⁺₁₈kₑ资产评估：430 V; total flow: 26.5 sccm) combined with cycles of O₂ (cycle time: 3.0/5 min) to remove polymer deposition. The RIE is followed by a 1-min wet etch in concentrated H₂SO₄. Fig. 1 shows that there is a slower etching in the middle of the trenches when the aspect ratio becomes high enough. We believe this lag effect is caused by shadowing of ions and neutral radicals as in the Si-RIE case [8]. The ridge height can be lowered to remove the lag but this increases the optical losses in the contact layers because of the weakly confined mode needed for good mode-locking. A simple improved design would be to use fourth-order gratings where the increased index difference compensates the reduced number of reflections and increases the total reflection. An even better solution would be to grow a slightly lower ridge (~200 nm) with the combination of an epitaxial etch-stop layer (AlInAs).

Cyclotene 3022–35 is used for passivation and for support of the pillars. The chips are cleaved to a length of ~4.4 mm, and mounted in the same way as in [6]. After mounting, a 98% high reflectance (HR) coating is applied to the absorber facet. Furthermore, a ~10⁻⁴ antireflection (AR) coating is applied to the DBR facet to ensure low facet reflections. The DBR section is also contacted and driven in forward bias during all mode-locking experiments to compensate for the losses in that section.
III. Measurements

The average threshold current for the five DBR lasers that were mode-locked was 40 mA ($I_{th}$: 0.45 kA/cm²) after both coatings had been applied, and the fiber-coupled output power in continuous-wave (CW) mode reached more than 15 mW. A Fabry–Pérot (FP) laser from the same wafer was made as reference and given an HR coating and a 5% AR coating. Typical light output–current ($I–L$) curves for DBR and FP lasers are shown in Fig. 2.

The 145-μm-long Bragg gratings are designed to have a center wavelength of 1550 nm and the measured center wavelengths were 1553 ± 2 nm (Fig. 3), a variation much smaller than the 15-nm variation of the gain peak across the wafer. The grating reflectivity versus wavelength is calculated from measurements of the modulation depth of the longitudinal modes from both facets (grating facet AR coated and other facet uncoated). The measured spectral widths of the gratings are ~2 nm and the measured peak reflection is ~1%. The low reflection can be explained by the fact that the duty cycle has not been properly transferred from the resist to the bottom of the etch, and by the mentioned lag effect.

Under uniform forward injection, the lasers are single-mode, while a negative absorber bias of more than $-2.2$ V results in passive mode-locking with a Gaussian spectrum and a background suppressed by >35 dB (Fig. 3). The fiber-coupled power during mode-locking typically exceeds 5 mW with a coupling loss of 3 dB. Frequency-resolved optical gating (FROG) was used to measure the pulse shapes (Fig. 4) and typical 3-dB widths ranged between 3.7 and 6 ps, depending on bias conditions, with time-bandwidth products of 0.4–0.5 (with 6.3 ps/nm added linear dispersion in single-mode fiber). The uncompressed pulsewidths from the FP laser were measured to be 2 ps in accordance with our earlier reported FP laser results [9]. The spectra of the FP laser show the same broad high-energy tail as many other reported monolithic FP MLLs based on quantum wells [9], [10]. Thus, for a fair comparison of the time-bandwidth product, we have chosen the 1/e widths instead of the more common half-maximum widths. The TBP1/e is 5 for the FP laser and 2 for the DBR (uncompressed pulses).

Hybrid mode-locking is performed by modulating the absorber bias with a ~9.9-GHz sinusoid from a synthesizer (R&S SMR40), amplified to 26 dBm. The absorber bias needs to be increased to ~ $-5$ V to obtain good hybrid mode-locking. No major change in pulsewidth or spectral width could be observed with the addition of the RF signal, indicating that the filter limits the pulse shortening. By reducing the RIE lag, it is possible to use a shorter grating with a wider filter and thereby obtain short pulses as for the FP lasers. The RF spectrum becomes much narrower in hybrid operation, indicating a good lock to the modulating synthesizer signal. An upper limit to the timing jitter is measured with an RF spectrum analyzer from the phase noise in the fundamental RF line as outlined in [11] [Fig. 5(a)]. The phase-noise plateau of the DBR laser is $-120$ dB/Hz and would produce a jitter of 200 fs ($\rightarrow 80$ MHz) if the synthesizer were noiseless. Integrating the measured phase noise according to the
characterization of the mode-locking, including phase noise and relative intensity noise (RIN) spectra. The DBR lasers are more suitable for optical fiber communications than 10-GHz FP lasers from the same wafer, and to our knowledge, also outperform the best earlier 10-GHz DBR-MMLLs [4], [5] made by regrowth. We believe that we can improve the gratting and thereby the lasers considerably by small adjustments to the existing epitaxial design and also by improving our processing. We believe that such single epitaxy lasers will be able to produce high-quality pulses as short as 1 ps, with transform-limited spectra, with average power-coupled powers of 10 mW and with timing jitter below 100 fs. This is a suitable candidate for the commercialization of monolithic semiconductor mode-locked lasers.

ACKNOWLEDGMENT

The authors acknowledge P. Shi for valuable help with the e-beam process.

REFERENCES